

S3A THRU S3M

SURFACE MOUNT FAST RECOVERY RECTIFIER



FEATURES

- Plastic package has underwrites laboratory flammability Classification 94V-0
- For surface mounted applications
- Low profile package
- Built-in strain relief, ideal for automated placement
- Glass Passivated chip junction
- High temperature soldering:
250 °C /10 second at terminals

MECHANICAL DATA

- Case: JEDEC DO-214AA molded plastic over glass passivated chip
- Terminals: Solder plated, Solderable per MIL-STD-750, method 2026
- Polarity: Color band denotes cathode end
- Weight: 0.007ounce, 0.25 gram

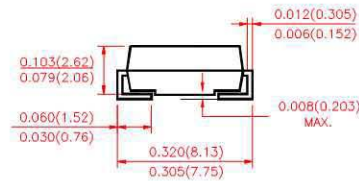
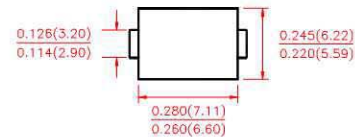
VOLTAGE RANGE

50 to 1000 Volts

CURRENT

3.0 Ampere

DO-214AB(SMC)



Dimensions in inches and (millimeters)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

- Ratings at 25°C ambient temperature unless otherwise specified

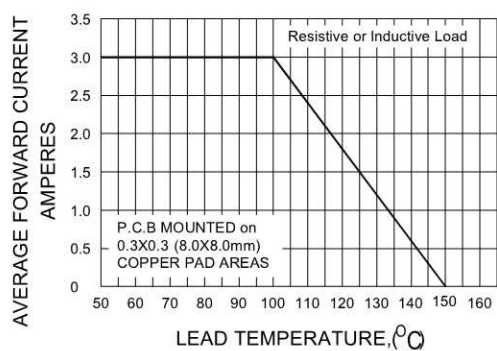
		SYMBOLS	S3A	S3B	S3D	S3G	S3J	S3K	S3M	UNIT
Maximum Repetitive Peak Reverse Voltage		V _{RRM}	50	100	200	400	600	800	1000	Volts
Maximum RMS Voltage		V _{RMS}	35	70	140	280	420	560	700	Volts
Maximum DC Blocking Voltage		V _{DC}	50	100	200	400	600	800	1000	Volts
Maximum Average Forward Rectified Current at T _L =100 (NOTE 3)		I _(AV)	3.0							Amps
Peak Forward Surge Current 8.3ms single half sine wave superimposed on rated load (JEDEC method) T _L =100		I _{FSM}	100							Amps
Maximum Instantaneous Forward Voltage at 3.0A		V _F	1.15							Volts
Maximum DC Reverse Current at rated DC Blocking Voltage	T _A = 25	I _R	10.0							A
	T _A = 125		250							
Typical Reverse Recovery Time (NOTE 1)		T _{rr}	2.5							s
Typical junction capacitance (NOTE 2)		C _J	60							pF
Typical Thermal Resistance (NOTE 3)		R _{θJL}	47							°C/W
		R _{θJA}	13							
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +150							°C

Notes:

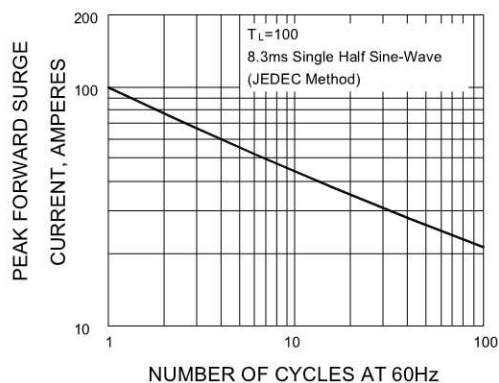
- Reverse recovery test conditions: $I_F=0.5A$, $I_R=1.0A$, $I_{rr}=0.25A$
- Measured at 1.0MHz and applied reverse voltage of 4.0 Volts
- Thermal resistance from Junction to ambient and from junction to lead mounted on P.C.B. with 0.3×0.3" (8.0×8.0mm) copper pad areas.

RATINGS AND CHARACTERISTIC CURVES S3A THRU S3M

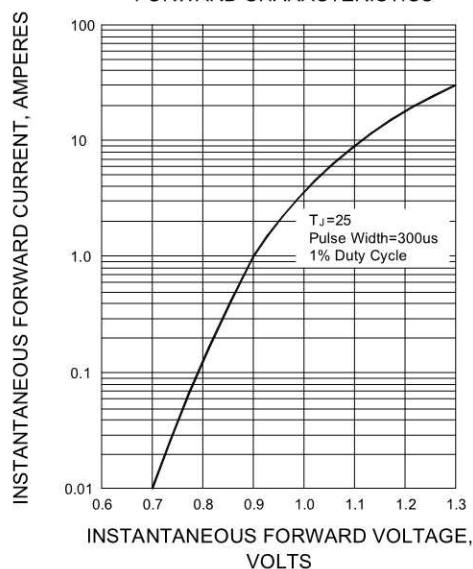
F1G.1-FORWARD CURRENT DERATING CURVE



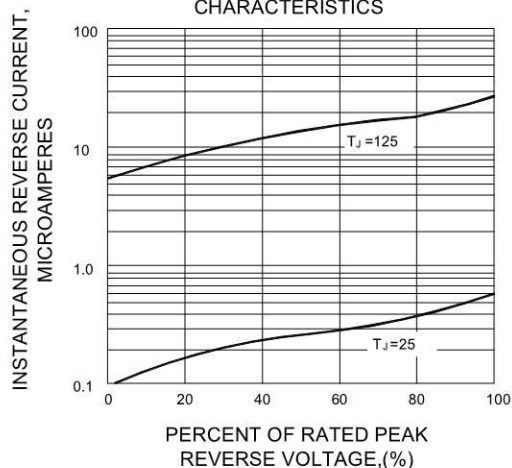
F1G.2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT



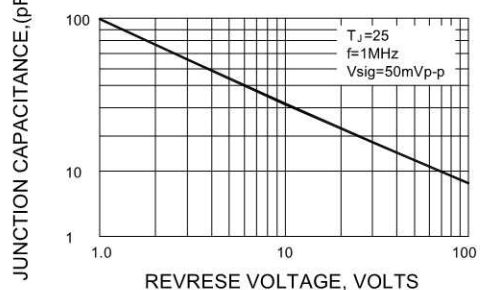
F1G.3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS



F1G.4-TYPICAL REVERSE CHARACTERISTICS



F1G.5-TYPICAL JUNCTION CAPACITANCE



F1G.6-TYPICAL TRANSIENT THERMAL IMPEDANCE

